# 1981812-1 ACTIVE

#### Micro SLP

TE Internal #: 1981812-1

Wire-to-Board, 2 Position, .8 mm [.031 in] Centerline, Insulation Displacement (IDC), 1 Row, Black, Wire & Cable, Power & Signal

View on TE.com >



Connectors > PCB Connectors > Wire-to-Board Connectors > Wire-to-Board Connector Assemblies & Housings











Connector System: Wire-to-Board

Number of Positions: 2

Centerline (Pitch): .8 mm [ .031 in ]

Termination Method to Wire & Cable: Insulation Displacement (IDC)

Number of Rows: 1

#### **Features**

Product Type Features	
Connector System	Wire-to-Board
Sealable	No
Connector & Contact Terminates To	Wire & Cable
Configuration Features	
Number of Positions	2
Number of Rows	1
Body Features	
Primary Product Color	Black
Contact Features	
Contact Current Rating (Max)	1 A
Termination Features	
Termination Method to Wire & Cable	Insulation Displacement (IDC)
Mechanical Attachment	

Locking Clip

Mating Retention Type



Mating Retention	With
Connector Mounting Type	Cable Mount (Free-Hanging)
Housing Features	
Centerline (Pitch)	.8 mm[.031 in]
Usage Conditions	
Operating Temperature Range	-25 – 85 °C[-13 – 185 °F]
Operation/Application	
Circuit Application	Power & Signal

### **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC
Halogen Content	Low Bromine/Chlorine - Br and Cl < 900 ppm per homogenous material. Also BFR /CFR/PVC Free
Solder Process Capability	Hand solderable with lead free solder

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

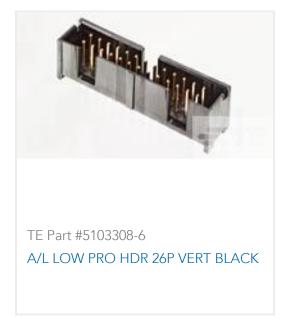
# **Compatible Parts**





# Customers Also Bought





















#### **Documents**

**CAD Files** 

3D PDF

English

Customer View Model

ENG\_CVM\_1981812-1\_B.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_1981812-1\_B.3d\_stp.zip

English

Wire-to-Board, 2 Position, .8 mm [.031 in] Centerline, Insulation Displacement (IDC), 1 Row, Black, Wire & Cable, Power & Signal



**Customer View Model** 

ENG\_CVM\_1981812-1\_B.2d\_dxf.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

Products for Mobile Equipment

English

**Product Specifications** 

**Application Specification** 

Japanese